350W CCM PFC for Refrigerator

Designed for: Public Release

Assembly Variant: [No Variations]

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These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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